

PATENTIN THE UNITED STATES PATENT OFFICE

Serial No.: Not yet assigned

Filed: Herewith

For: METHOD OF FORMING A CONDUCTIVE PATTERN ON DIELECTRIC SUBSTRATES

Inventors: Michael Guggemos, Franz Kohnle

Atty Doc. No.: 009-02

PRELIMINARY AMENDMENTAssistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please amend the above-identified patent application as follows:

In the Claims:

Please amend the claims as follows:

3. (amended) Method according to any one of claims 1-2 [of the preceding claims], **characterised in that** laser radiation is used as the UV radiation.
- 4.(amended) Method according to any one of claims 1-2 [the preceding claims], **characterised in that** the protective layer is removed, using a pulsed excimer laser, in the metal film regions to be exposed in method step b).
5. (amended) Method according to claim 3 [one of the preceding claims], **characterised in that** a mask through which UV radiation passes is used to copy the conductive pattern onto the substrate covered with the metal film.
6. (amended) Method according to claim 1 [one of the preceding claims], **characterised in**